## ELECTRO-MECHANICS

## SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Thick - Film chip RESISTOR
- Samsung P/N: RC6432J***CS
- Description : 6432, $\pm 5 \%,(1 \Omega \sim 10 M \Omega), 1 W$


## A. Samsung Part Number

$\frac{\mathrm{RC}}{(1)} \frac{6432}{\text { (2) }} \quad \frac{\mathrm{J}}{\text { (3) }} \quad \frac{* * *}{\text { (4) }} \quad \frac{\mathrm{CS}}{(5)}$

## (1) Code designation

Samsung Thick - Film Chip Resistor
(2) Dimension

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6432(\mathrm{~mm} \text { code }) \quad \mathrm{L}: 6.3 \pm 0.2 \quad \mathrm{~mm} \quad \mathrm{~W}: 3.2 \pm 0.2 \quad \mathrm{~mm}
$$ $\pm 5 \%$

(3) Resistancs tolerance
(4) Nominal resistance value
※3digits Left 2 digits : Resistance value, Right 1 digits : Exponential number of 10.
ex) $101: 10 \times 10^{1}=10 \times 10=100 \Omega$
※4digits Left 3 digits : Resistance value, Right 1 digits : Exponential number of 10.
ex) $4222: 422 \times 10^{2}=422 \times 100=42.2 \mathrm{k} \Omega$
Read alphabet "R" as decimal point "000": Jumper(0 0
ex) $3 R 7: 3.7=3.7 \Omega / 88 R 7: 88.7=88.7 \Omega$

Packing code
7" Reel packaging

## B. Samsung Reliablility Test and Judgement condition

|  | Judgement |  | Test condition |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Resistor | Jumper | Resistor | Jumper |
| Direct Current Resistance | Within the regulated resistance tolerance. | 50ms Max | Voltage apply Within 5 sec |  |
| Short-time Overload | Less than $\pm(1 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | Apply 2.5 times rated voltage for 5sec | Max Surge Current |
| Intermittent Overload | Less than $\pm(3 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | 2.5 times of rated voltage. <br> 1 sec On, 25 sec Off / 10,000cycles | Max Surge Current |
| Dielectric <br> Withstanding Voltage <br> Insulation <br> Resistance | No evidence of mechanical damage |  | Apply Voltage for 1 minute 0603:50v \|1005,1608:100v <br> Other: 500v |  |
| Temperature <br> Characteristic | $\begin{aligned} & \square \text { J-Grade } \\ & 1 \Omega \leq \mathrm{R}<10 \Omega:+300 /-200 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & 10 \Omega \leq \mathrm{R} \leq 1 \mathrm{M} \Omega: \pm 100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}(0603 \pm 250 \mathrm{ppm}) \\ & 1 \mathrm{M} \Omega<\mathrm{R} \leq 10 \mathrm{M} \Omega: \pm 300 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \text { F-Grade } \\ & 10 \Omega \leq \mathrm{R} \leq 1 \mathrm{M} \Omega: \pm 100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}(0603 \pm 250 \mathrm{ppm}) \end{aligned}$ |  | Test Temperature ( $\left.{ }^{\circ} \mathrm{C}\right) 20^{\circ} \mathrm{C} \rightarrow-55^{\circ} \mathrm{C} / 20^{\circ} \mathrm{C} \rightarrow 125^{\circ} \mathrm{C}$ $\text { T.C.R }\left(\mathrm{ppm} /{ }^{\circ} \mathrm{C}\right)=\frac{R-R_{0}}{R_{0}} \times \frac{1}{T-T_{0}} \times 10^{6}$ <br> $\mathrm{To}: 20 \pm 2^{\circ} \mathrm{C}, \mathrm{RO}$ : Resistance at TO ( $\Omega$ ) <br> $\mathrm{T}:$ Test temperature $, \mathrm{R}:$ Resistance at $\mathrm{T}(\Omega)$ |  |
| Solderability | Coverage: $95 \% \leq$ each termination. |  | Solder Temp : $245^{\circ} \mathrm{C}$ <br> Dipping time : 3 sec |  |


|  | Judgement |  | Test condition |
| :---: | :---: | :---: | :---: |
| Bending test | Less than $\pm(0.5 \%+0.05 \Omega)$ of the initial value No evidence of mechanical damage | $50 \mathrm{~m} \Omega$ Max | 3 mm of bending shall be applied for 5 sec . |
| Adhesive strength of termination | No mechanical damage or sign of disconnection |  | Test strengh : 5N <br> Test time: Applying pressure for 10seconds |
| Resistance to soldering heat | Less than $\pm(1 \%+0.05 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | $260 \pm 5^{\circ} \mathrm{C}, 10 \mathrm{sec}$ |
| Anti-Vibration test | Less than $\pm(1 \%+0.05 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | Test amplitude : 1.5 mm <br> Frequency $10 \mathrm{~Hz}-55 \mathrm{~Hz}-10 \mathrm{~Hz} / 2 \mathrm{hr}$ in $\mathrm{x}, \mathrm{y}, \mathrm{z}$ direction. |
| Temperature cycle | Less than $\pm(1 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | 100 cycles, $\quad-55^{\circ} \mathrm{C} / 30 \mathrm{~min} \leftrightarrow 125^{\circ} \mathrm{C} / 30 \mathrm{~min}$ sweep time:5min |
| Load life | Less than $\pm(3 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | Test voltage: rated voltage $/ 70 \pm 2^{\circ} \mathrm{C}$ <br> 1,000hours(90min:On , 30min:Off) |
| Low Temp. <br> Exposure | Less than $\pm(3 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | Dwell in $-55^{\circ} \mathrm{C}$ chamber without loading for 1,000hours |
| High Temp Exposure | Less than $\pm(3 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | Dwel in $125^{\circ} \mathrm{C}$ or $155^{\circ} \mathrm{C}$ chamber without loading for 1,000hours |
| Moisture <br> Resistance | Less than $\pm(3 \%+0.1 \Omega)$ of the initial value No evidence of mechanical damage | 50m $\Omega$ Max | Test voltage: rated voltage / $40 \pm 2^{\circ} \mathrm{C}$ <br> 1,000hours(90min:On,30min:Off) / 90~95\% RH |

## C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : $260+0 /-5^{\circ} \mathrm{C}, 10 \mathrm{sec}$. Max )

* For the more detail Specification, Please refer to the samsung chip RESISTOR catalogue.

